# NP0G3D1

# Silicon PNP epitaxial planar type (Tr1) Silicon NPN epitaxial planar type (Tr2)

### For digital circuits

#### ■ Features

- Two elements incorporated into one package
- Optimum for high-density mounting and downsizing of the equipment
- Allowing automatic insertion with the taping

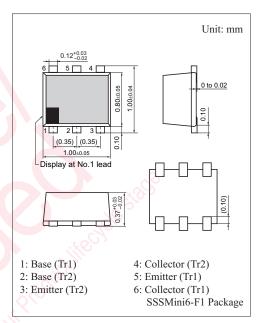
#### ■ Basic Part Number

• UNR31A3 + UNR32AL

## ■ Absolute Maximum Ratings $T_a = 25$ °C

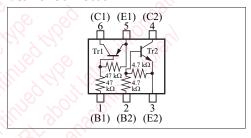
Parameter		Symbol	Rating	Unit	
Tr1	Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-50	v	
	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-50	V	
	Collector current	$I_{\rm C}$	-80	mA	
Tr2	Collector-base voltage (Emitter open)	V <sub>CBO</sub>	50	NOW ON	
	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	50	S V	
	Collector current	$I_{\rm C}$	80	mA	
Overall	Total power dissipation *	$P_{T}$	125	mW	
	Junction temperature	Tj	125	°C	
	Storage temperature	$T_{stg}$	-55 to +125	°C	

Note) \* : Measuring on substrate at 17 mm  $\times$  10 mm  $\times$  1 mm



### Marking Symbol: 3A

### Internal Connection



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## ■ Electrical Characteristics $T_a = 25$ °C±3°C

### • Tr1

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	$I_{\rm C} = -10 \ \mu A, I_{\rm E} = 0$	-50			V
Collector-emitter voltage (Base open) *	V <sub>CEO</sub>	$I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$	-50			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = -50 \text{ V}, I_E = 0$			-0.1	μΑ
Collector-emitter cutoff current (Base open)	$I_{CEO}$	$V_{CE} = -50 \text{ V}, I_{B} = 0$			- 0.5	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = -6 \text{ V}, I_C = 0$			-0.1	mA
Forward current transfer ratio	$h_{FE}$	$V_{CE} = -10 \text{ V}, I_{C} = -5 \text{ mA}$	80			_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = -10 \text{ mA}, I_B = -0.3 \text{ mA}$			- 0.25	V
Output voltage high-level	V <sub>OH</sub>	$V_{CC} = -5 \text{ V}, V_{B} = -0.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$	-4.9			V
Output voltage low-level	V <sub>OL</sub>	$V_{CC} = -5 \text{ V}, V_{B} = -3.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$			-0.2	V
Input resistance	$R_1$		-30%	47	+30%	kΩ
Resistance ratio	$R_1/R_2$		0.8	1.0	1.2	_
Transition frequency	$f_{T}$	$V_{CB} = -10 \text{ V}, I_E = 1 \text{ mA}, f = 200 \text{ MHz}$	~1	80		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

#### • Tr2

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \mu\text{A}, I_{\rm E} = 0$	50			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 2 \text{ mA}, I_B = 0$	50		ijo,	V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 50 \text{ V}, I_{E} = 0$	160		0.1	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = 50 \text{ V}, I_{B} = 0$	Υ	11/1/10	0.5	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 6 \text{ V}, I_{C} = 0$	S X		2.0	mA
Forward current transfer ratio	$h_{FE}$	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}$	20			_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA}$	600.		0.25	V
Output voltage high-level	V <sub>OH</sub>	$V_{CC} = 5 \text{ V}, V_{B} = 0.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$	4.9			V
Output voltage low-level	$V_{OL}$	$V_{CC} = 5 \text{ V}, V_{B} = 2.5 \text{ V}, R_{L} = 1 \text{ k}\Omega$	60		0.2	V
Input resistance	$R_1$	6/10 0. "IND "ICO.	-30%	4.7	+30%	kΩ
Resistance ratio	$R_1/R_2$	MOM COLL	0.8	1.0	1.2	_
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_{E} = -2 \text{ mA}, f = 200 \text{ MHz}$		150		MHz

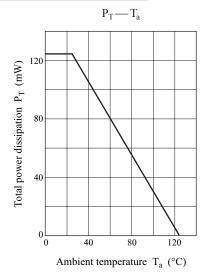
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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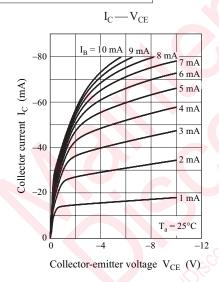
<sup>2. \*:</sup> Pulse measurement

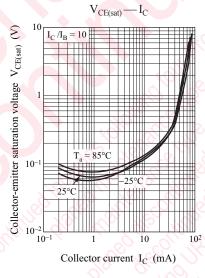
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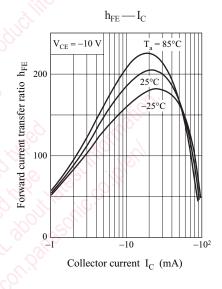
### Common characteristics chart

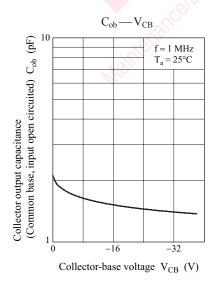


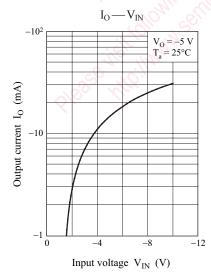
### Characteristics charts of Tr1

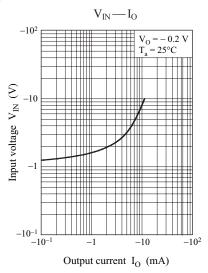






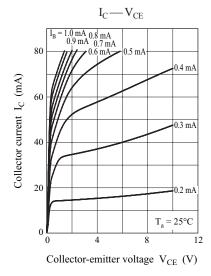


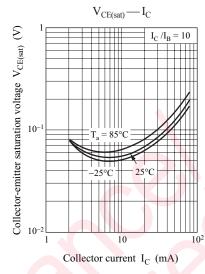


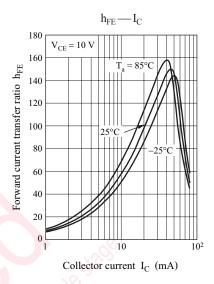


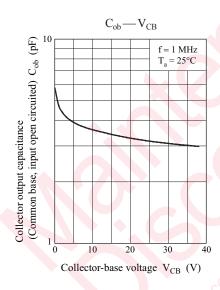
NP0G3D1 Panasonic

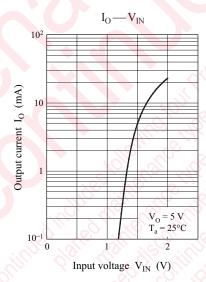
### Characteristics charts of Tr2

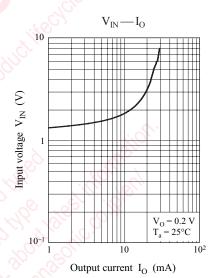












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